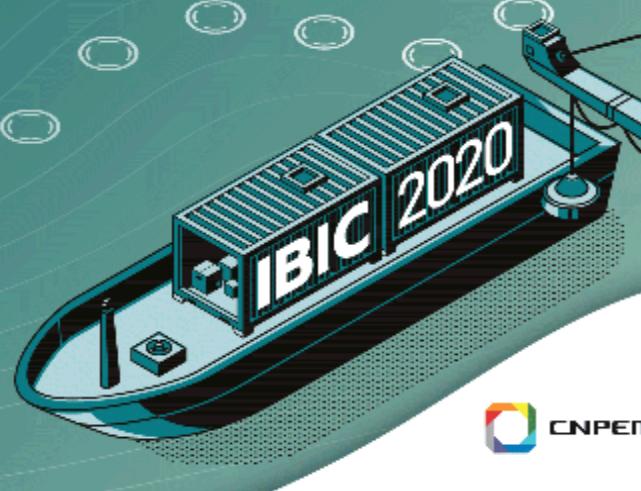


Brazil

14 - 18

September



Brief Introduction to HEPS BPM Electronics Development

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Beam Instrumentation Group, IHEP, CAS, China

September 14-18 2020

IBIC2020, Brazil

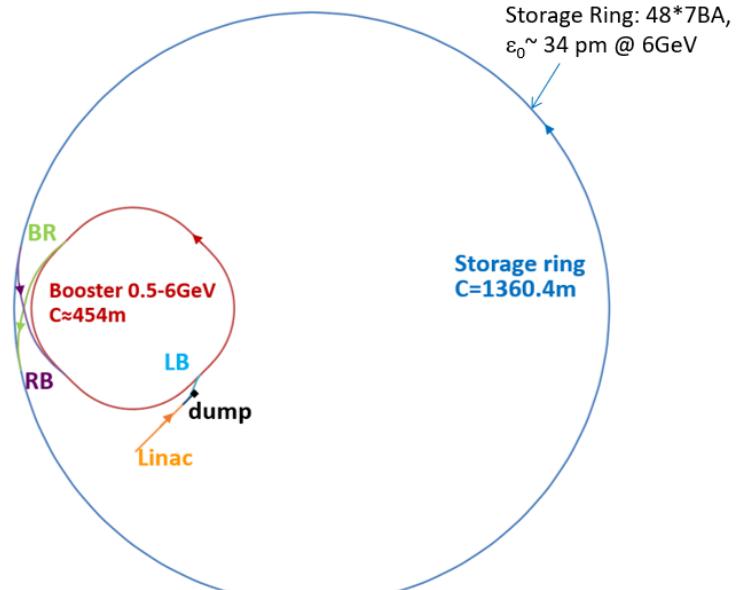
Outline

- 1. The HEPS Storage Ring BPM requirement**
- 2. BPM electronics design of HEPS project**
- 3. BPM electronics upgrading work in BEPCII project**
- 4. The plan of Pilot Tone Hardware used in HEPS**
- 5. Summary and Acknowledgement**

1. The HEPS Storage Ring BPM requirement

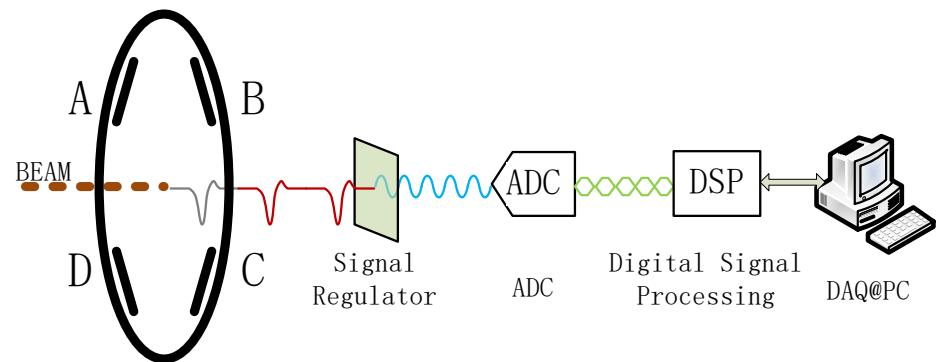
A quick introduction to the HEPS project

- The **High Energy Photon Source (HEPS)** is designed as an ultra-low emittance ring-based synchrotron radiation light ;
- About fourteen beamlines will be constructed in Phase I of the project;
- Storage ring circumference: 1360m, 48*7BA
- Energy: 6GeV
- Emittance: 60pm.rad
- Current: >200mA



Schematic of HEPS Complex

The Digital BPM requirement of HEPS project



■ HEPS BPM quantities

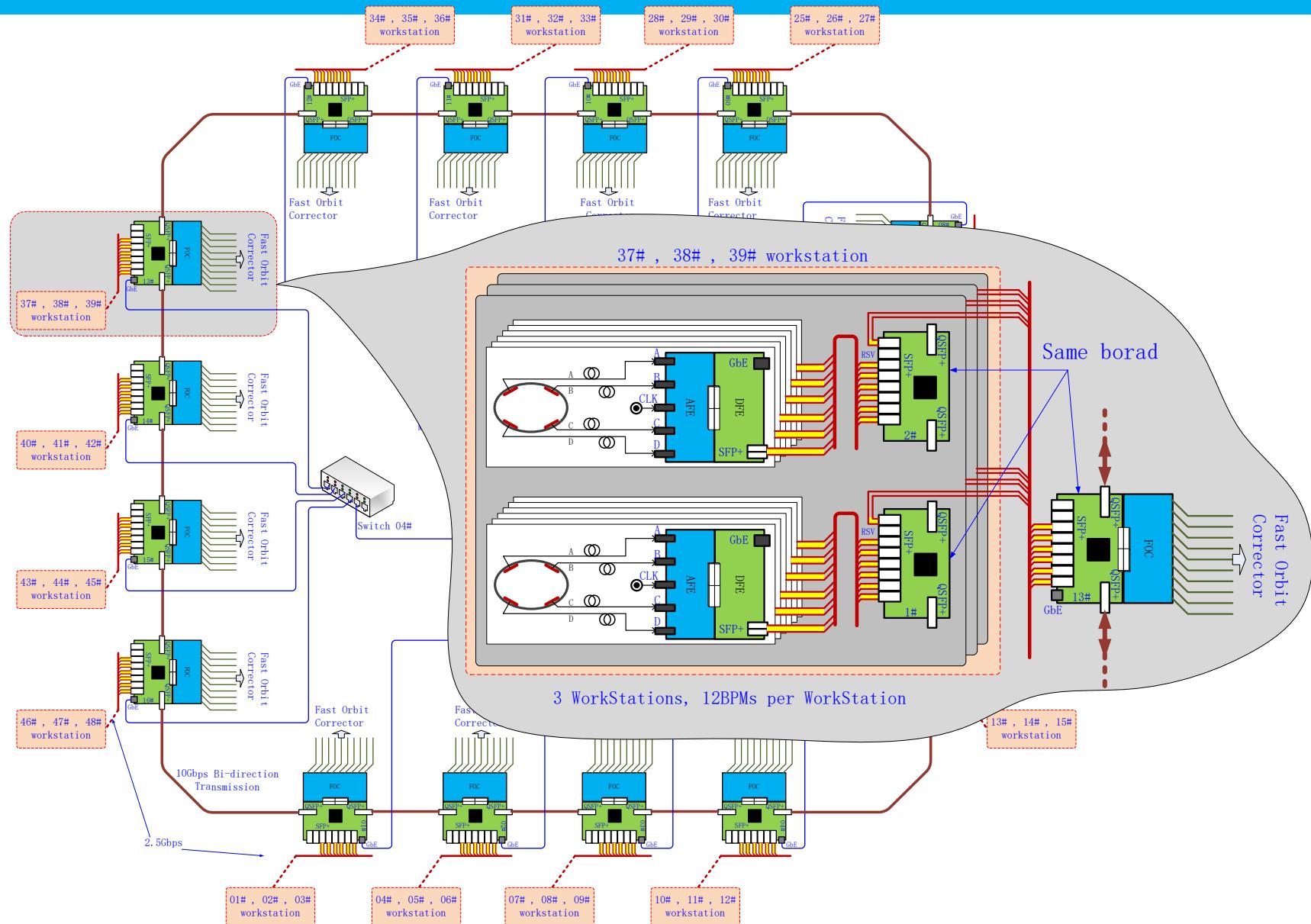
	BPM Quantities
Linac	7
Transfer Line	$3 * 10 = 30$
Booster	80
Storage Ring	$48 * 12 + 2 = 578$
SUM	695

■ Storage ring BPM Parameters

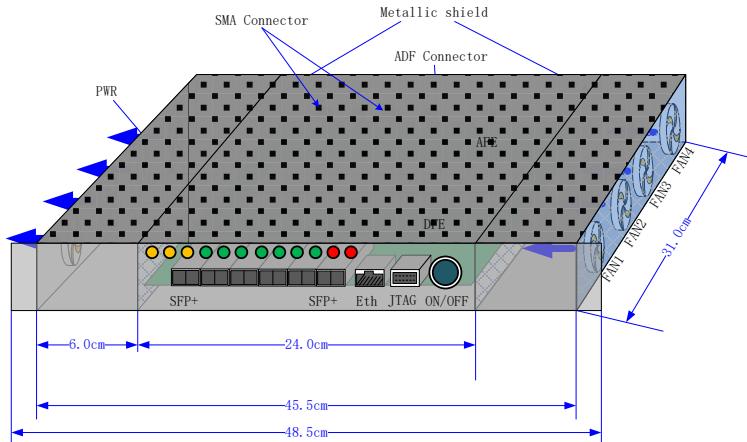
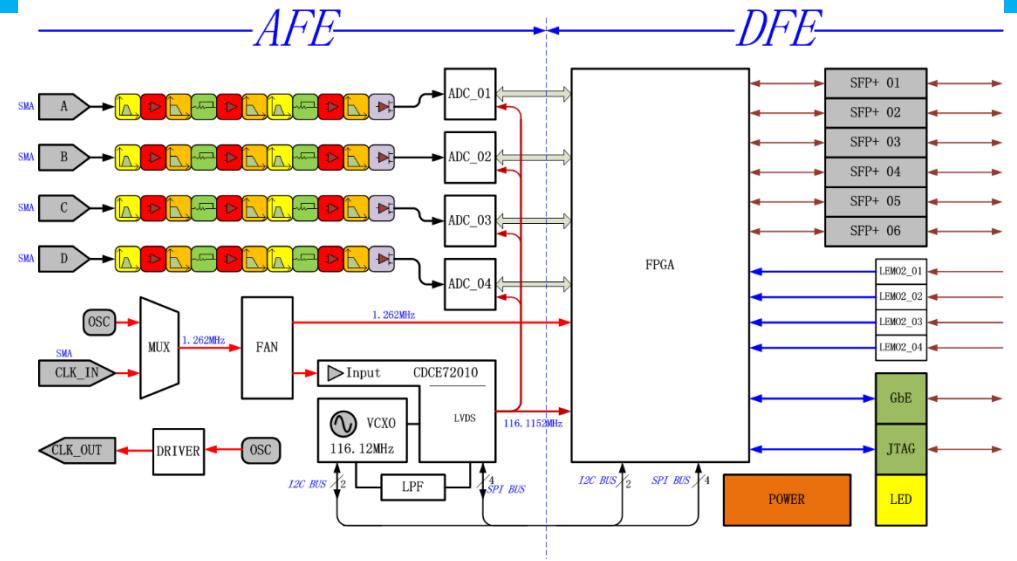
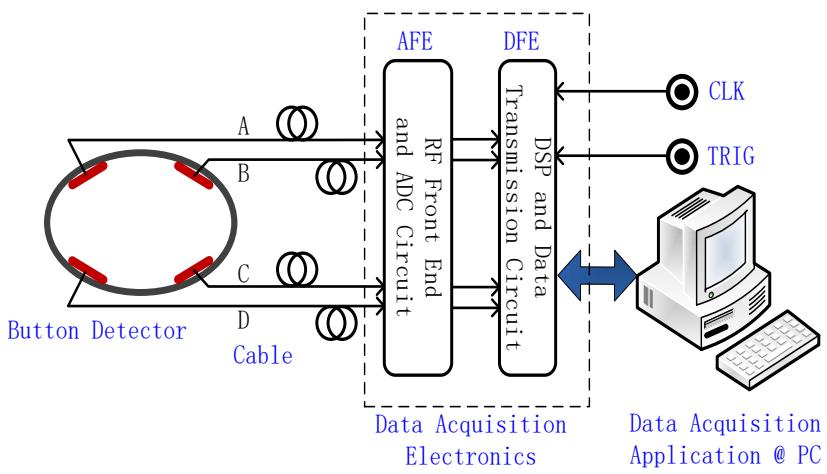
	DBPM@HEPS
Turn by Turn Data	<u>1μm @220kHz</u>
FA data	<u>0.3μm @22KHz</u>
COD data	<u>0.1μm @10Hz</u>

2. BPM electronics design of HEPS project

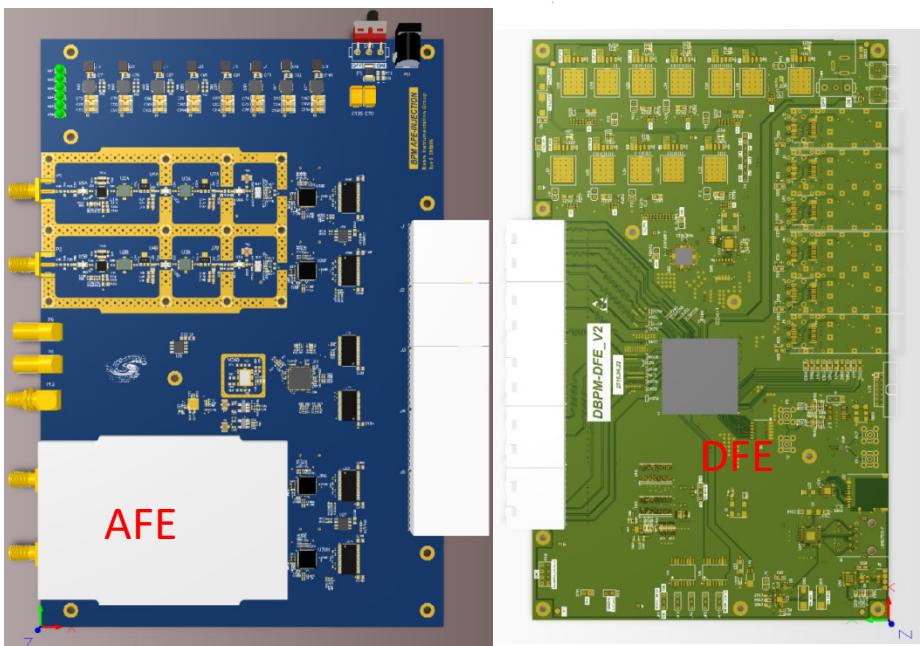
2.1 FOFB Framework and DBPM architecture



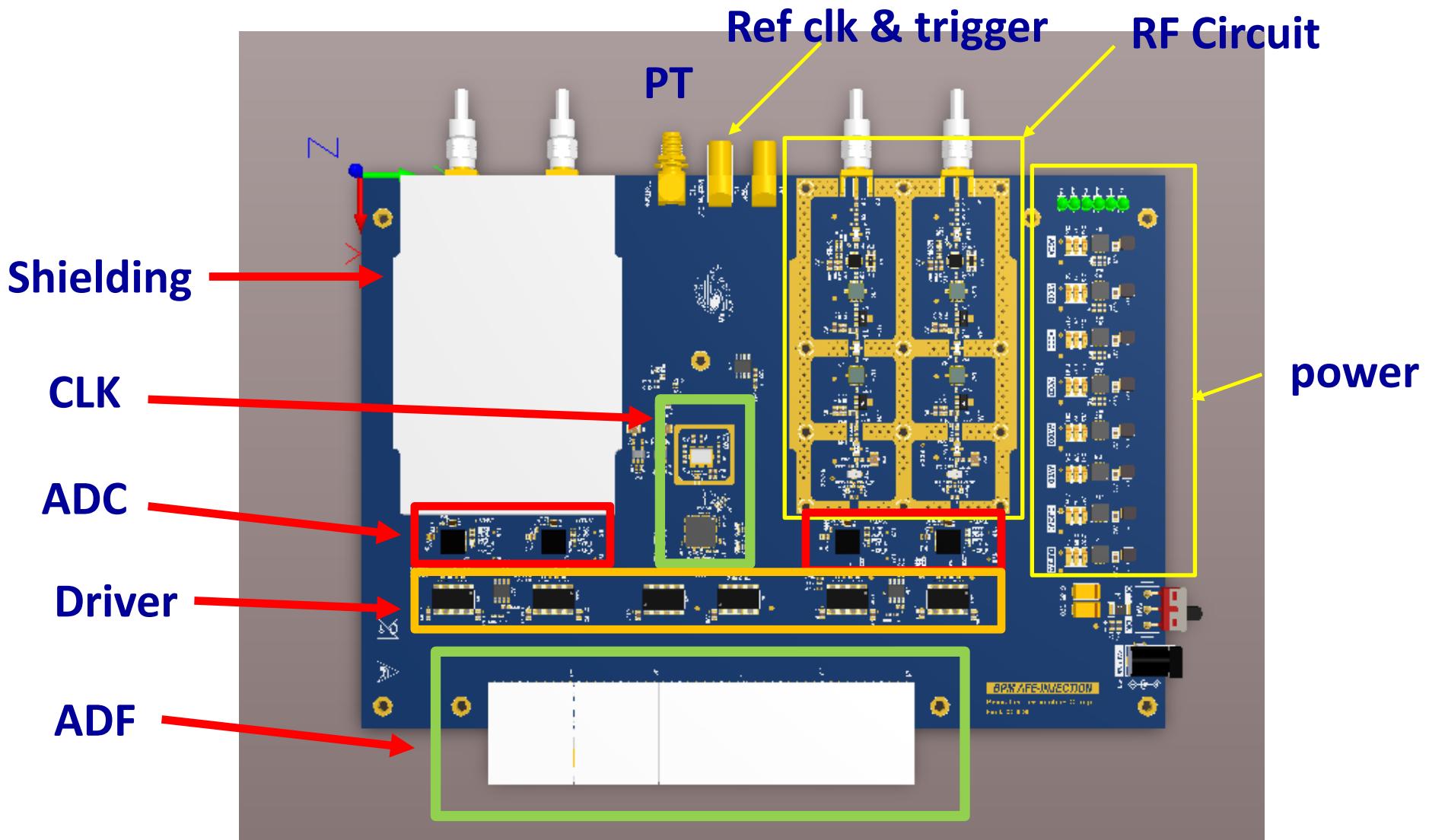
2.2 DBPM Electronics design



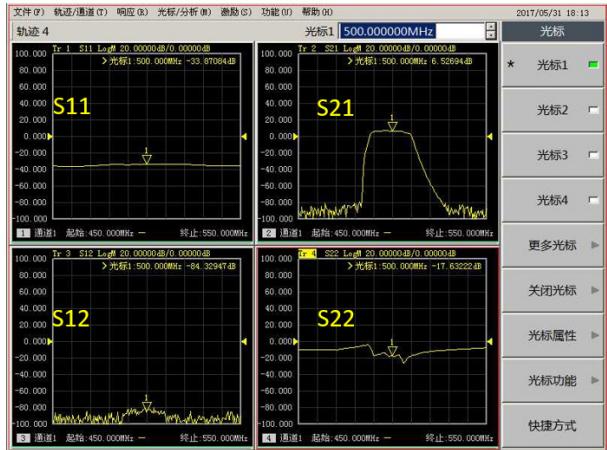
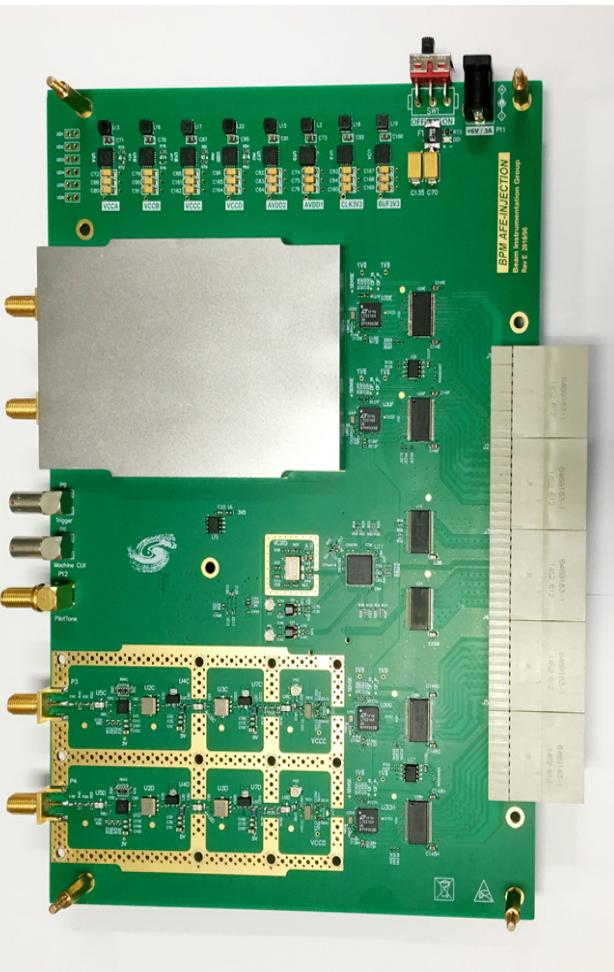
(By HuiZhou Ma)



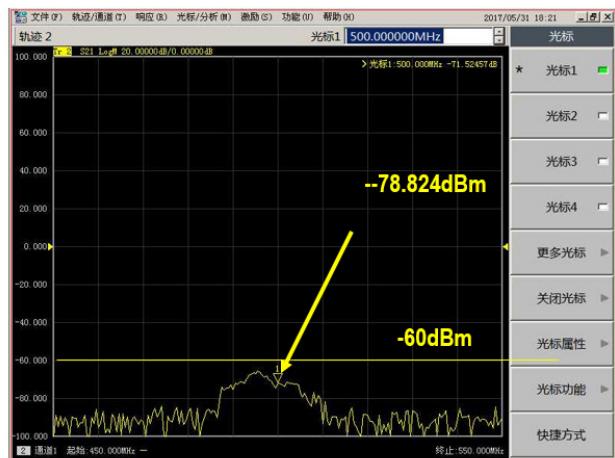
■ AFE electronic Design



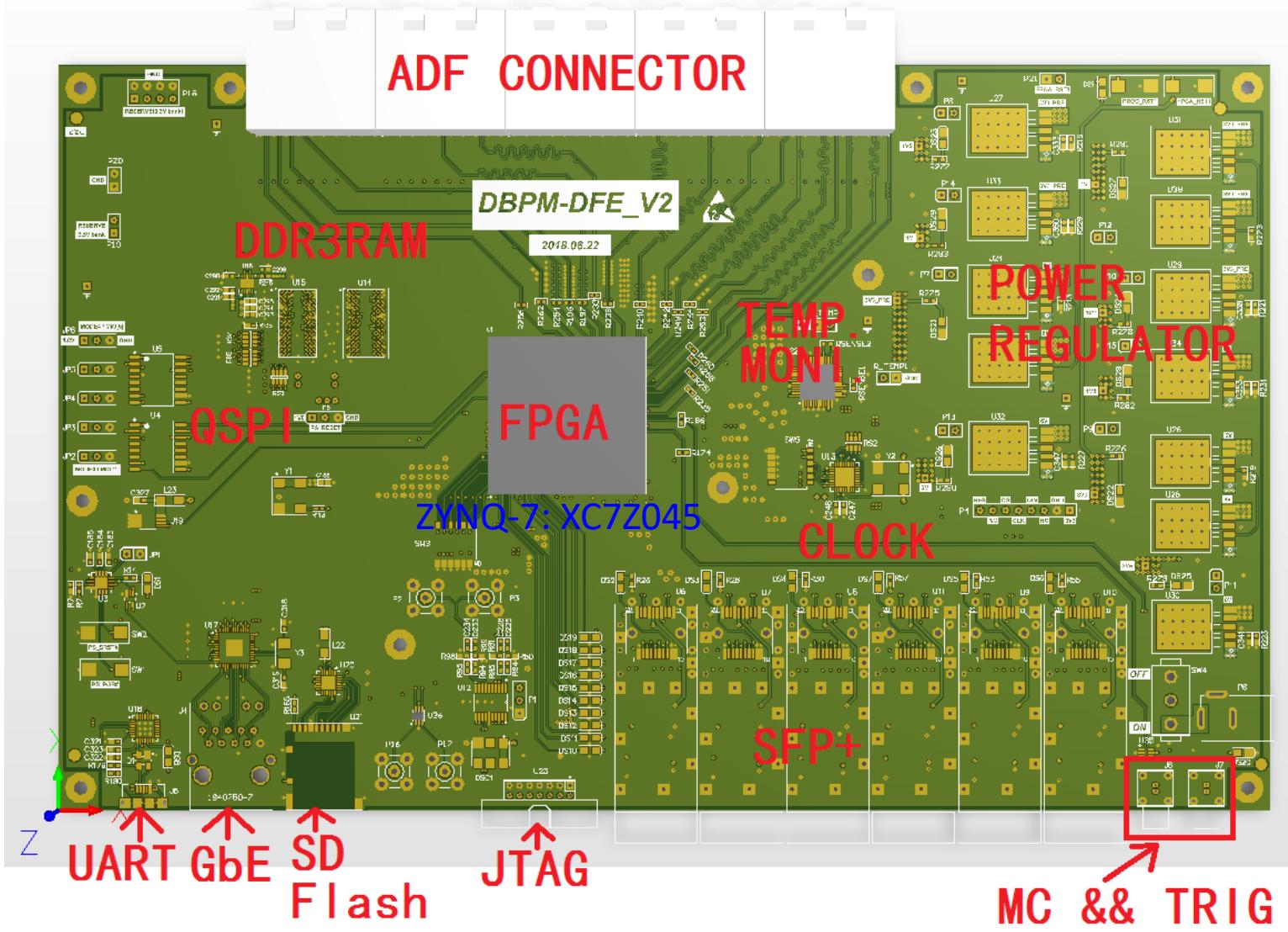
AFE Analog logic Testing



Channel to Channel Isolation > 60dB



■ DFE electronic Design

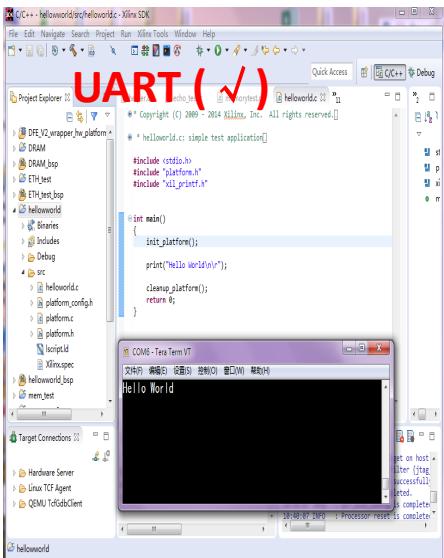
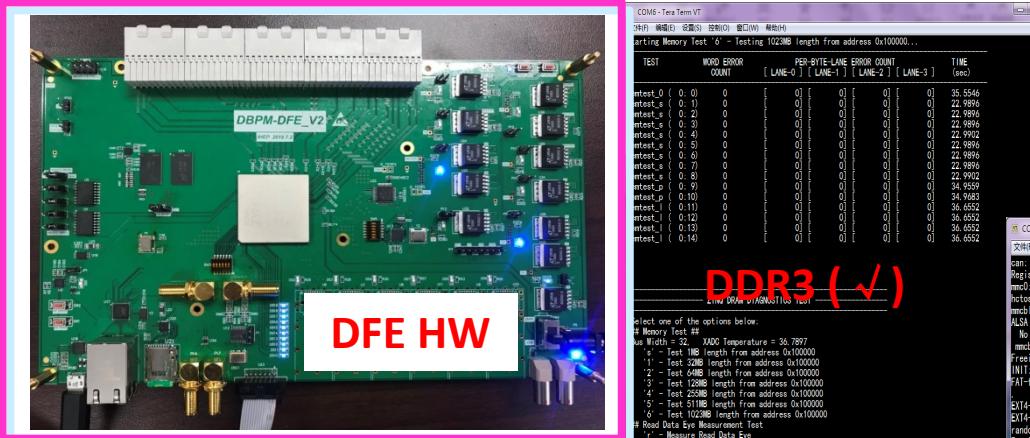
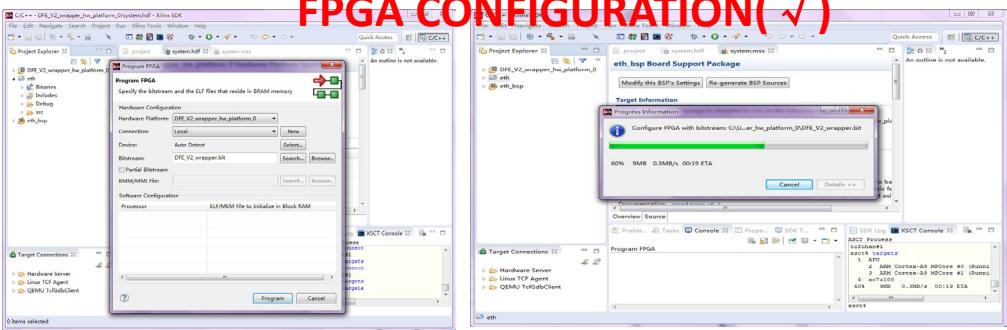


DFE Hardware Testing

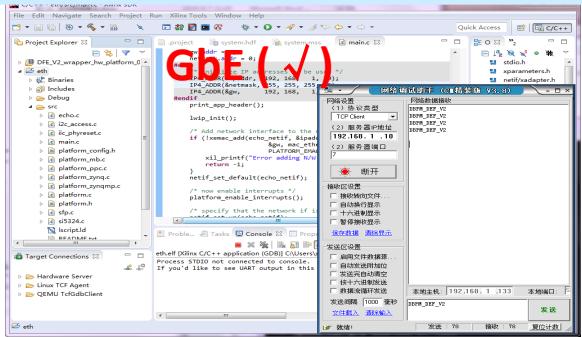
DFE POWER(✓)

设计电压(V)	实测电压(V)	用电引脚
1	1.006	VCCINT, VCCPINT, VCCBRAM, ETH,
1	1.003	MGTAVCC
1.2	1.213	GTX_MGTAVTT
1.5	1.494	VCCO, DDR3
1.8	1.780	VCCPAUX, VCCPLL, VCCOMIO, VCCAUX, MGTAVCCAUX, UART, SD, I2C
2	1.998	VCCAUX_IO
2.5	2.513	VCCO
3.3	3.315	VCCO, ETH, JTAG, QSPI, POR,
3.3_pre	3.295	1.5V, 1.2V, 1V

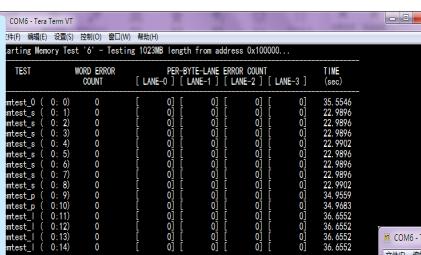
FPGA CONFIGURATION(✓)



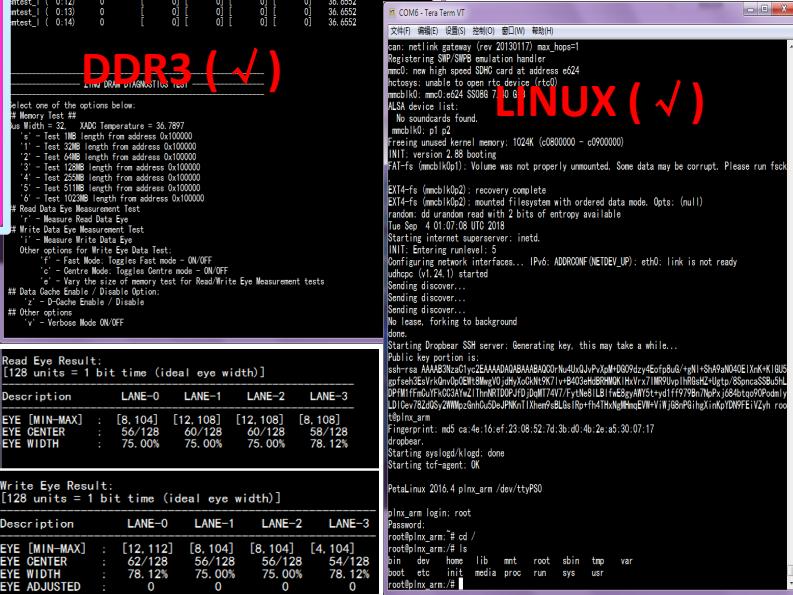
GbE(✓)



DDR3(✓)



LINUX(✓)



2.3 The HEPS BPM electronics Integration Testing

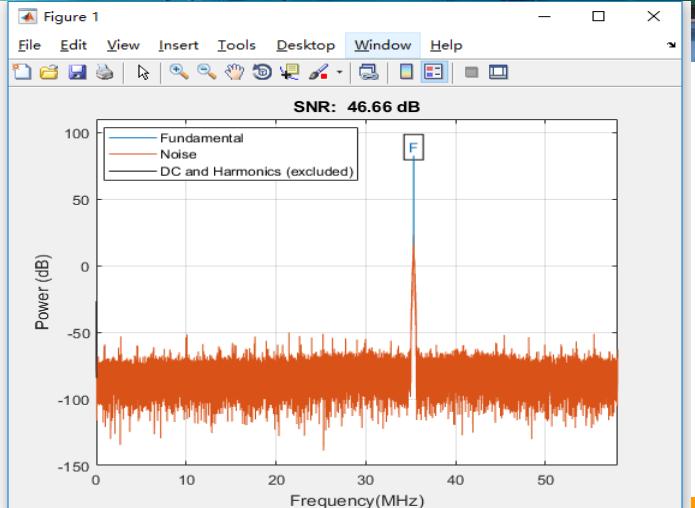
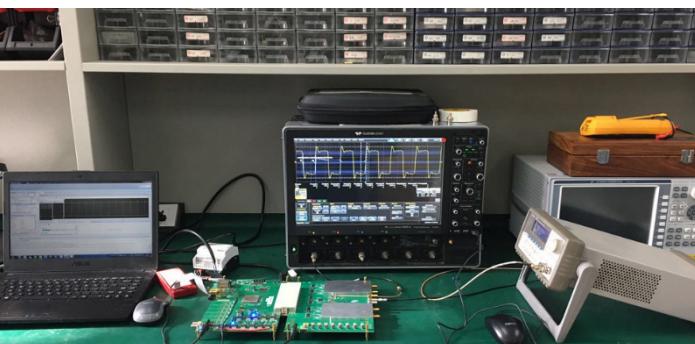
■ ADC Clock testing

- <1ps RMS Jitter

■ RAW Data testing in laboratory

- RAW data SNR: ~46.6dB
- Process (RAW data to TBT) gain from digital BPF:~20dB

* *FFT Process gain is not included!*



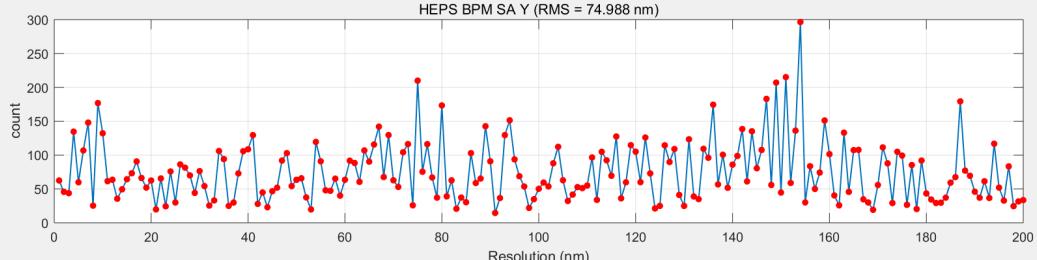
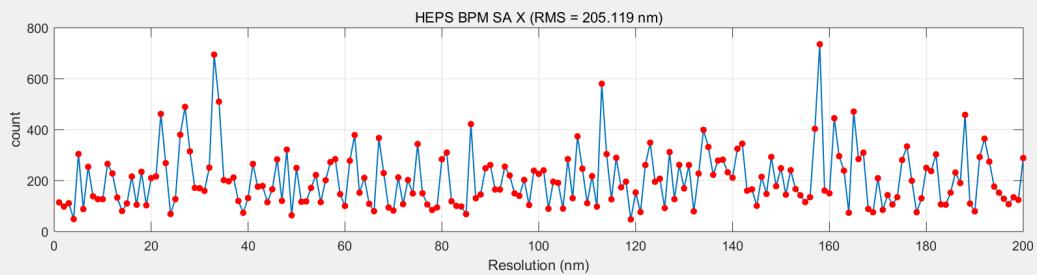
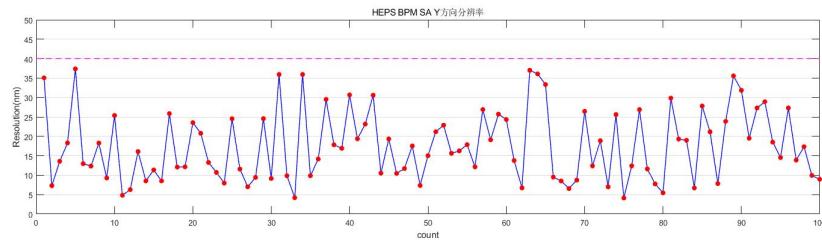
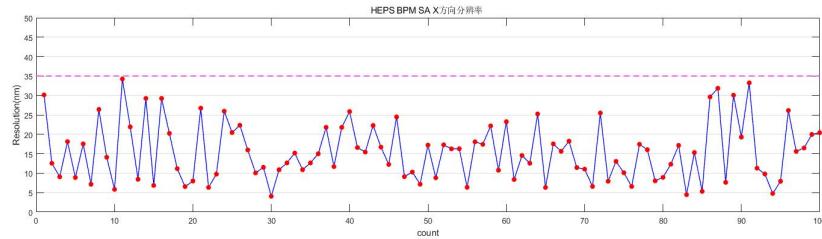
The HEPS BPM electronics Performance Testing

■ SA data resolution

STD testing

($K_x = K_y = 8.26\text{mm}$)

- Better than
50nm@Laboratory
- Better than
100nm@ BEPCII
Real beam



3. BPM electronics upgrading work in BEPCII project

Why we do the BEPCII BPM electronics upgrading work, and why is it important.

- The Bergoz BPM electronics in BEPCII have been worked more than 10 years, some of them broke down now.
- The work can bring benefit to the HEPS' BPM building.
 - The main function and performance of HEPS' BPM electronics can be proofed.
 - Any design flaws in BPM electronics can be found and solved during BEPCII BPM upgrading job.
 - The long-term stability of BPM electronics will be examined.
 - The mass production capacity of BPM electronics will be verified.

What we have done and what we are about to be done in our upgrading job

- BEPCII Linac BPM electronics upgrading work have been finished in 2019.
- Storage Ring BPM electronics upgrading work of BEPCII will be completed in 2021

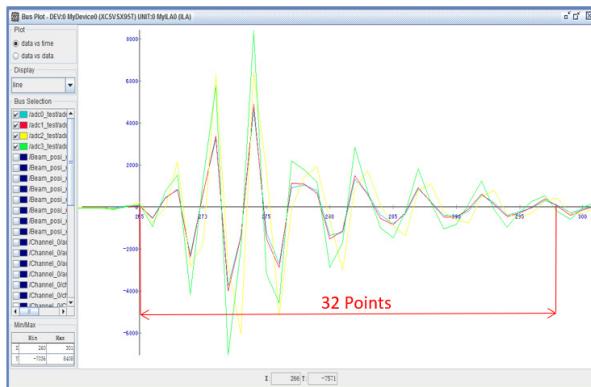


BEPCII Linac BPM electronics upgrading work

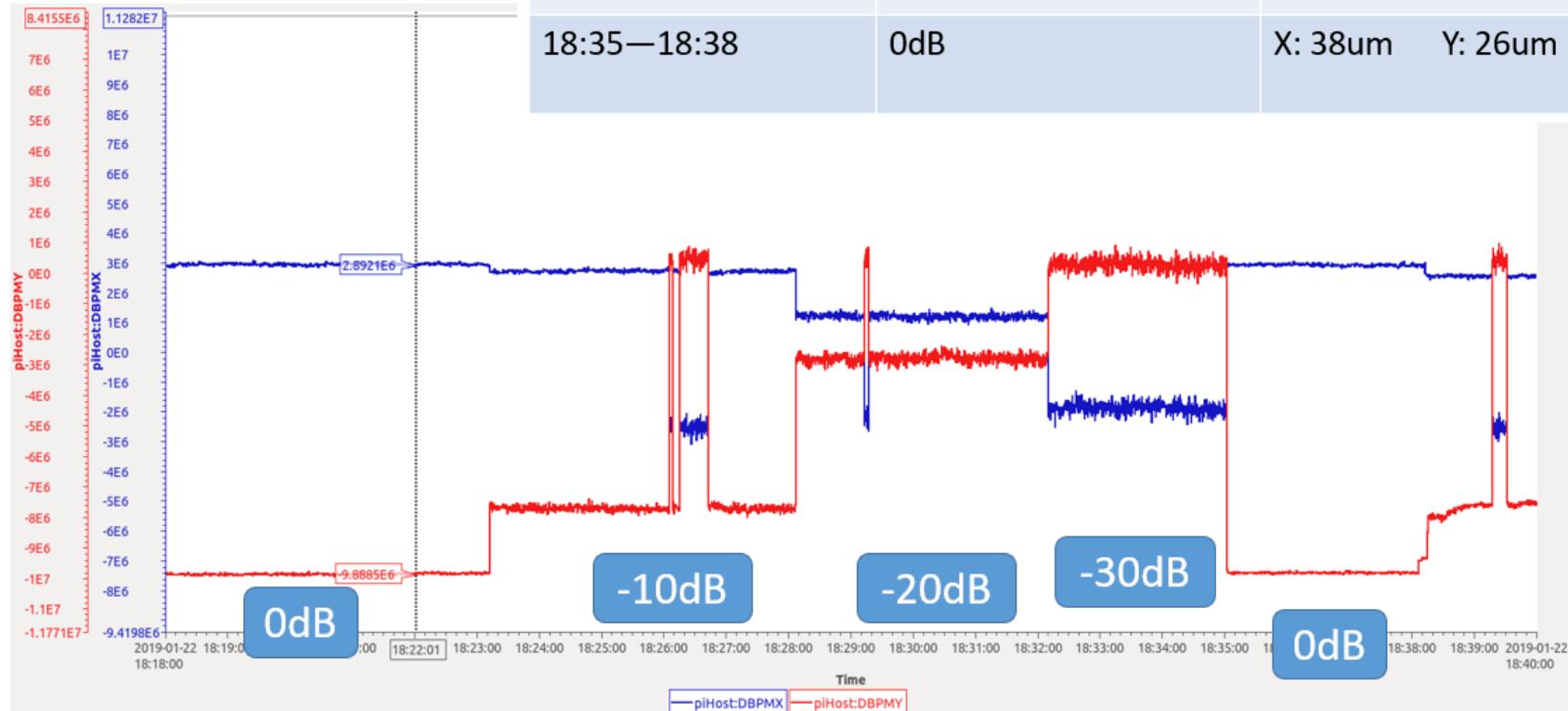
- About 20 Linac BPM electronics upgrading were completed in 2019



Resolution testing with real beam in BEPCII LINAC



TIME	ATTENUATION SETTING	RESOLUTION	
18:18—18:23	0dB	X: 38um	Y: 26um
18:23—18:28	-10dB	X: 55um	Y: 40um
18:28—18:32	-20dB	X: 85um	Y: 70um
18:32—18:35	-30dB	X: 120um	Y: 100um
18:35—18:38	0dB	X: 38um	Y: 26um

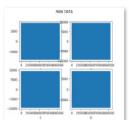


BEPCII SR BPM electronics upgrading work

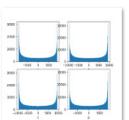
■ All BEPCII Storage Ring BPM electronics will be upgraded within 2 years. Half of the total , about 50 BPM electronics, will complete the installation in 2020. And the rest will be installed in 2021.



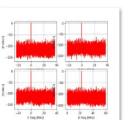
15.txt



Figure_1.png



Figure_2.png



Figure_3.png

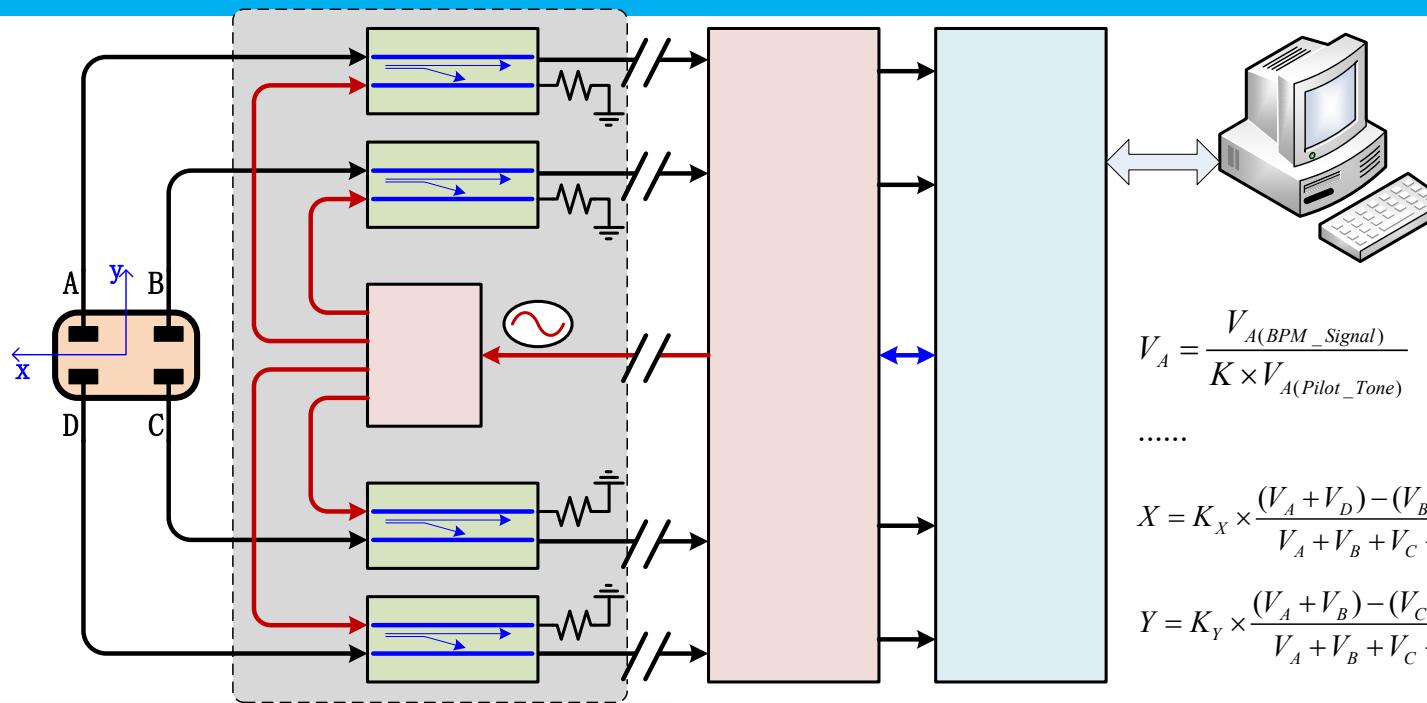


捕获.PNG



4. The plan of Pilot Tone HW used in HEPS

Pilot-Tone scheme and hardware

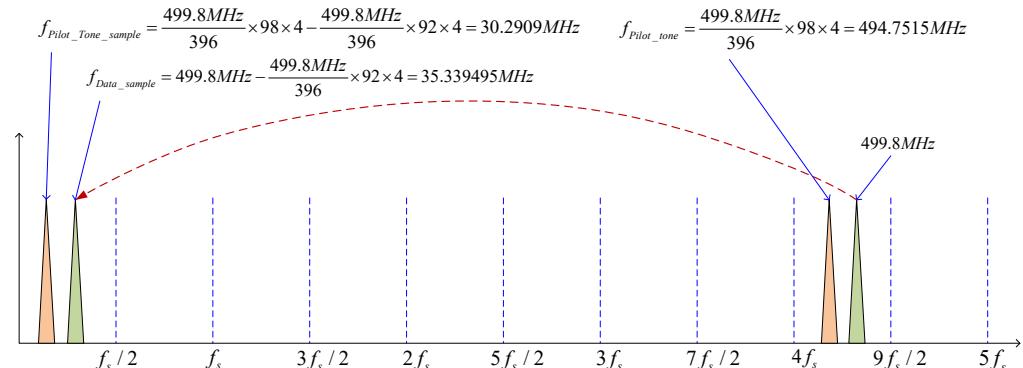


$$V_A = \frac{V_{A(BPM_Signal)}}{K \times V_{A(Pilot_Tone)}}$$

.....

$$X = K_X \times \frac{(V_A + V_D) - (V_B + V_C)}{V_A + V_B + V_C + V_D} + X_{offset}$$

$$Y = K_Y \times \frac{(V_A + V_B) - (V_C + V_D)}{V_A + V_B + V_C + V_D} + Y_{offset}$$



$$f_{Sample} = \frac{499.8MHz}{396} \times 92 = 116.11515152MHz$$

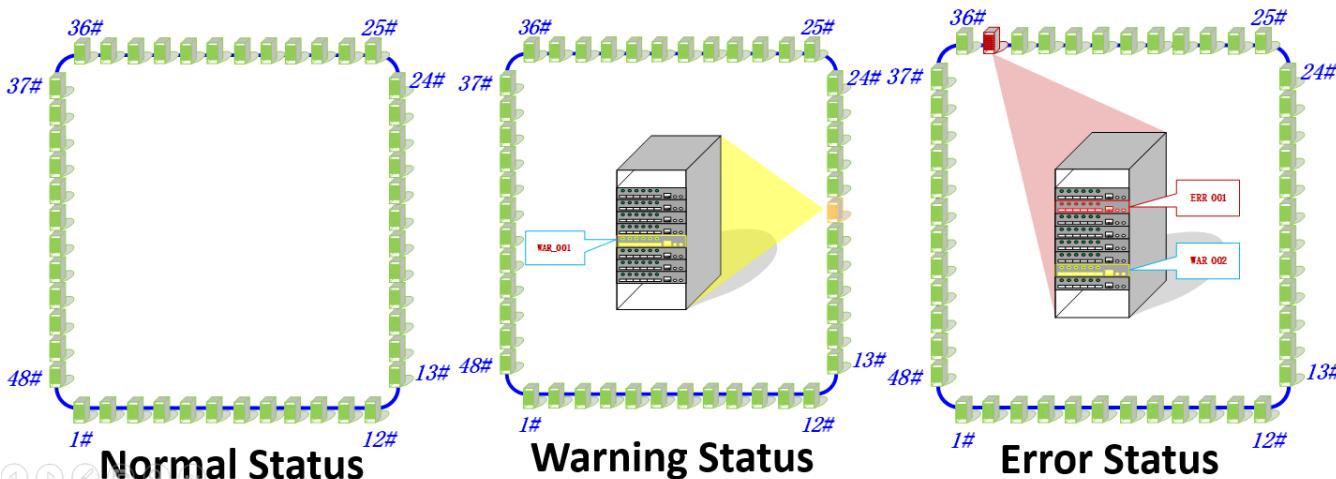
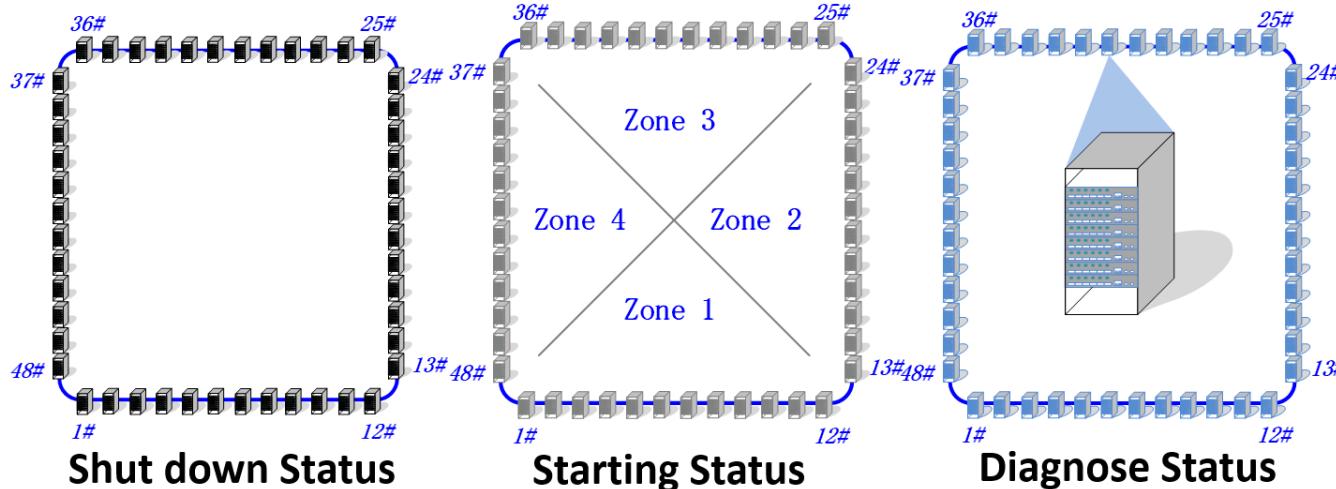
$$f_{NCO} = \frac{499.8MHz}{396} \times 27.5 = 34.7083333MHz$$

The expected functions of Pilot tone logic in HEPS project.

- BPM system self-testing without beam.
- BPM electronics channels on-line calibration.
- BPM electronics on-line diagnosis.
- *The on-line correction measurement is our long-term target.*

Prospective monitor interface in workstation

Different colors for different operating states



5. Summary and Acknowledgement

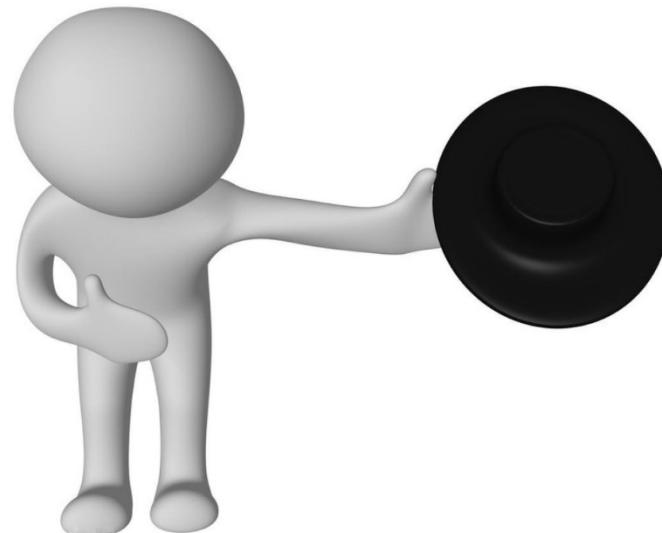
Summary

- Digital BPM Electronics hardware and algorithm has been designed carefully and had been tested in laboratory;
- The digital BPM electronics have been tested with the real beam on BEPCII.
- The digital BPM electronics have been used to replace the BEPCII's old Bergoz BPM electronics.
- Pilot Tone hardware will be built in HEPS project and used in special purpose.

Acknowledgement

■ During our Digital BPM electronic development, we got many experts help, and I would like to take this opportunity to express my sincere appreciation to those experts.

- SIRIUS
- SSRF
- HLS
- I-Tech
- ...



Thanks for your attention